

# **DS1235Y/AB** 256K Nonvolatile SRAM

T-46-23-37

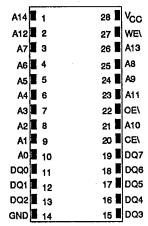
#### **FEATURES**

- Data retention in the absence of V<sub>cc</sub>
- Data is automatically protected during power
- Directly replaces 32K x 8 volatile static RAMs or EEPROMs
- Unlimited write cycles
- Low-power CMOS
- Over 5 years of data retention
- Standard 28-pin JEDEC pinout
- Available in 100, 120, 150, and 200 ns read access times
- Read cycle time equals write cycle time
- · Lithium energy source is electrically disconnected to retain freshness until power is applied for the first time
- Full ± 10% operating range (DS1235Y)
- Optional ± 5% operation range (DS1235AB)

## DESCRIPTION

The DS1235Y/AB 256K Nonvolatile SRAM is a 262, 144-bit, fully static SRAM organized as 32,768 words by 8 bits. The nonvolatile memory has a self-contained lithium energy source and control circuitry that constantly monitors V<sub>co</sub> for an out-of-tolerance condition. When such a condition occurs, the lithium energy source is automatically switched on and write protection is unconditionally enabled to prevent garbled data.

## PIN DESCRIPTION



28-PIN ENCAPSULATED PACKAGE (720 Mil Extended)

## PIN NAMES (\ Denotes Condition Low)

A0 - A14

- Address Inputs

CE\

- Chip Enable

**GND** 

- Ground

DQ0-DQ7

- Data In/Data Out

- Power (+5V)

V<sub>cc</sub> WE\

- Write Enable

OE\

- Output Enable

The nonvolatile SRAM can be used in place of existing 32K x 8 SRAMs directly conforming to the popular bytewide 28256 EEPROM, allowing direct substitution while enhancing performance. There is no limit on the number of write cycles that can be executed and no additional support circuitry is required for microprocessor interface.

070290 1/7

T-46-23-37

**READ MODE** 

The DS1235Y/AB executes a read cycle whenever WE\ (Write Enable) is inactive (high) and CE\ (Chip Enable) is active (low). The unique address specified by the 15 address inputs (An-A<sub>14</sub>) defines which of the 32,768 bytes of data is to be accessed. Valid data will be available to the eight data output drivers within  $t_{\mbox{\scriptsize ACC}}$  (Access Time) after the last address input signal is stable, providing that CE\ and OE\ (Output Enable) access times are also satisfied. If OE\ and CE\ access times are not satisfied, then data access must be measured from the later occurring signal (CE\ or OE\) and the limiting parameter is either t<sub>co</sub> for CE\ or t<sub>oe</sub> for OE\, rather than address access.

#### WRITE MODE

The DS1235Y/AB is in the write mode whenever the WE\ and CE\ signals are in the active (low) state after address inputs are stable. The latter occurring falling edge of CE\ or WE\ will determine the start of the write cycle. The write cycle is terminated by the earlier rising edge of CE\ or WE\. All address inputs must be kept valid throughout the write cycle. WE\ must return to the high state for a minimum recovery time (twe) before another cycle can be initiated. The OE\ control signal should be kept inactive (high) during write cycles to avoid bus contention. However, if the output bus has been enabled (CE\ and OE\ active) then WE\ will disable the outputs in topy from its falling edge.

#### DATA RETENTION MODE

The nonvolatile SRAM provides full functional capability for  $V_{cc}$  greater than 4.5 volts and write protects by 4.25V nominal (V<sub>cc</sub> greater than 4.75V and write protect at 4.62V nominal for DS1235AB). Data is maintained in the absence of V<sub>cc</sub> without any additional support circuitry. The DS1235Y/AB constantly monitors V<sub>cc</sub>. Should the supply voltage decay, the RAM will automatically write protect itself; all inputs to the RAM become "don't care" and all outputs are high impedance. As V<sub>cc</sub> falls below approximately 3.0 volts, the power switching circuit connects the lithium energy source to RAM to

retain data. During power-up, when  $V_{cc}$  rises above approximately 3.0 volts, the power switching circuit connects external Vcc to the RAM and disconnects the lithium energy source. Normal RAM operation can resume after V<sub>cc</sub> exceeds 4.5 volts (4.75 volts for the DS1235AB).

#### FRESHNESS SEAL AND SHIPPING

The DS1235Y/AB is shipped from Dallas Semiconductor with the lithium energy source disconnected, guaranteeing full energy capacity. When V<sub>cc</sub> is first applied at a level of greater than V<sub>TP</sub>, the lithium energy source is enabled for battery backup operation.

## **BATTERY REDUNDANCY**

Battery redundancy ensures reliability. The DS1235Y/AB contains two lithium energy cells separated by an internal isolation switch. During battery backup time the cell with the highest voltage is selected for use. If one battery fails, the other battery automatically takes over. The switch between batteries is transparent to the

070290 2/7

DS1235Y/AB

T-46-23-37

**ABSOLUTE MAXIMUM RATINGS\*** 

Voltage on any Pin Relative to Ground

**Operating Temperature** 

Storage Temperature
Soldering Temperature

-0.3V to +7.0V

0°C to 70°C -40°C to +70°C

260°C for 10 seconds

\* This is a stress rating only and functional operation of the device at these or any other conditions outside those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

## RECOMMENDED DC OPERATING CONDITIONS

(0°C to 70°C)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
DS1235Y Power Supply	V <sub>cc</sub>	4,5	5.0	5.5	V	
Voltage			•			
DS1235AB Power Supply	V <sub>cc</sub>	4.75	5.0	4.25	V	
Voltage						
Logic 1	V <sub>IH</sub>	2.2		V <sub>cc</sub>	V	
Logic 0	V,,	0.0		+0.8	V	

 $(0^{\circ}\text{C to }70^{\circ}\text{C}; V_{cc}=5\text{V +/- }10\% \text{ for DS1235Y})$ 

# DC ELECTRICAL CHARACTERISTICS

(0°C to 70°C;  $V_{cc}$ =5V +/- 5% for DS1235AB)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Input Leakage Current	I <sub>L</sub>	-1.0		+1.0	иA	
I/O Leakage Current	l <sub>io</sub>	-1.0		+1.0	uА	
CE\≥V <sub>IH</sub> ≤V <sub>cc</sub>						ļ
Output Current @2.4V	l <sub>он</sub>	-1.0			mA	
Output Current @0.4V	l <sub>oL</sub>	2.0			mA	
Standby Current CE\ = 2.2V	I <sub>cos1</sub>		5.0	10.0	mA	
Standby Current CE\ = V <sub>cc</sub> -0.5V	I <sub>ccs2</sub>		3.0	5.0	mA	
Operating Current	I <sub>CC01</sub>		-	85	mA	
Write Protection Voltage (DS1235Y)	V <sub>TP</sub>	4.25	4.37	4.5	V	
Write Protection Voltage (DS1235AB)	V <sub>TP</sub>	4.50	4.62	4.75	V	

T-46-23-37 **CAPACITANCE** 

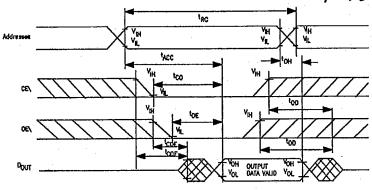
CAPACITANCE					(t <sub>A</sub> =25°0	
PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Input Capacitance	C <sub>IN</sub>		5	10	pF	
Input/Output Capacitance	C <sub>vo</sub>		5	12	pF	

(0°C to 70°C;  $V_{cc}$ =5.0V  $\pm$  10% for DS1235Y) (0°C to 70°C;  $V_{cc}$ =5.0V  $\pm$  5% for DS1235AB) **AC ELECTRICAL CHARACTERISTICS** 

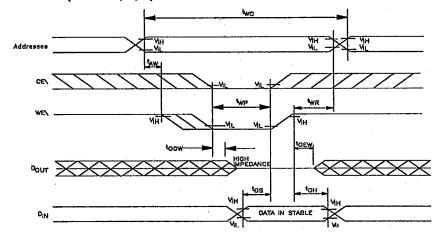
AC ELECTRICA	LOII	I	IENIO	1103		10 70	O, V <sub>C</sub>	<del>5-0.0</del>	<u> </u>	1	(235AB)
		DS123	5Y/AB-100	DS123	5Y/AB-120	DS123	5Y/AB-15	DS123	5Y/AB-200		
PARAMETER	SYM	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	UNITS	NOTES
Read Cycle Time	t <sub>RC</sub>	100		120		150		200		ns	
Access Time	tACC		100		120		150		200	ns	
OE\ to Output Valid	t <sub>OE</sub>		50		60		70		100	ns	
CE\ to Output Valid	t <sub>co</sub>		100		120		150		200	ns	
OE\ or CE\ to Output Active	t <sub>COE</sub>	5		5		5		5		ns	5
Output High Z From De- selection	t <sub>ob</sub>		35		40		70		100	ns	5
Output Hold From Address Change	t <sub>oH</sub>	5		5		5		5		ns	
Write Cycle Time	t <sub>wc</sub>	100		120		150		200		ns	
Write Pulse Width	t <sub>WP</sub>	75		90		100		150		ns	3
Address Setup Time	t <sub>AW</sub>	0		0		0		0		ns	
Write Recovery Time	t <sub>wa</sub>	20		20		20		20		ns	
Output High Z From WE\	t <sub>opw</sub>		35		40		70		80	ns	5
Output Active From WE\	t <sub>oew</sub>	5		5		5		5		ns	5
Data Setup Time	t <sub>DS</sub>	40		50		60		80		ns	4
Data Hold Time	t <sub>DH</sub>	20		20		20		20		ns	4

**READ CYCLE (Note 1)** 

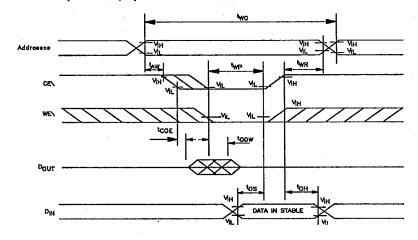
T-46-23-37



# WRITE CYCLE 1 (Notes 2, 6, 7)



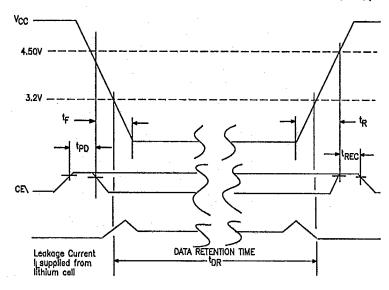
# WRITE CYCLE 2 (Notes 2, 8)



070290 5/7

# POWER-DOWN/POWER-UP CONDITION

T-46-23-37



# POWER-DOWN/POWER-UP TIMING

SYM	PARAMETER	MIN	MAX	UNITS	NOTES
t <sub>PD</sub>	CE\ at V <sub>IH</sub> before Power-Down	0		us	
t <sub>F</sub>	V <sub>cc</sub> slew from 4.5V to 0V (CE\ at V <sub>IH</sub> )	300		us	
t <sub>R</sub>	V <sub>cc</sub> slew from 0V to 4.5V (CE\ at V <sub>IH</sub> )	0		us	
t <sub>REQ</sub>	CE\ at V <sub>IH</sub> after Power-Up	2	125	ms	

 $(t_A = 25^{\circ}C)$ 

SYM	PARAMETER	MIN	MAX	UNITS	NOTES
t <sub>DR</sub>	Expected Data Retention Time	5		years	9

# **WARNING:**

Under no circumstance are negative undershoots, of any amplitude, allowed when device is in battery backup mode.

070290 6/7

### **NOTES**

1. WE\ is high for a read cycle.

T-46-23-37

- 2. OE\ = V<sub>IH</sub> or V<sub>IL</sub>. If OE\ = V<sub>IH</sub> during write cycle, the output buffers remain in a high impedance state.
- t<sub>wP</sub> is specified as the logical AND of CE\ and WE\.
   t<sub>wP</sub> is measured from the latter of CE\ or WE\ going low to the earlier of CE\ or WE\ going high.
- 4.  $t_{\rm DH}$ ,  $t_{\rm DS}$  are measured from the earlier of CE\ or WE\ going high.
- 5. These parameters are sampled with a 5 pF load and are not 100% tested.
- 6. If the CE\ low transition occurs simultaneously with or later than the WE\ low transition in Write Cycle 1, the output buffers remain in a high impedance state during this period.
- 7. If the CE\high transition occurs prior to or simultaneously with the WE\high transition in write Cycle 1, the output buffers remain in a high impedance state during this period.
- 8. If WE\ is low or the WE\ low transition occurs prior to or simultaneously with the CE\ low transition, the output buffers remain in a high impedance state during this period.
- 9. Each DS1235Y/AB has a built-in switch that disconnects the lithium source until  $V_{cc}$  is first applied by the user. The expected  $t_{pR}$  is defined as accumulative time in the absence of  $V_{cc}$  starting from the time power is first applied by the user.

## **DC Test Conditions**

Outputs Open t Cycle = 200ns All Voltages Are Referenced to Ground

## **AC Test Conditions**

Output Load: 100 pF + 1TTL Gate

Input Pulse Levels: 0-3.0V
Timing Measurement Reference Levels

Input: 1.5V Output: 1.5V

Input Pulse Rise and Fall Times: 5ns